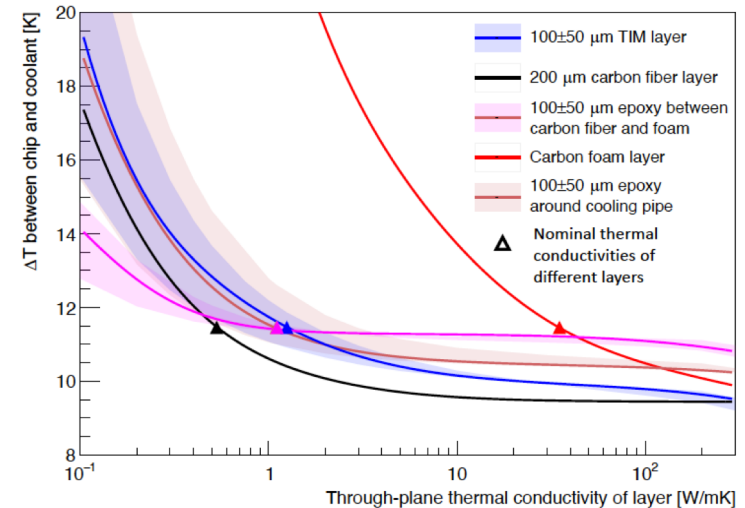


Light-weight minimal mass tracking detectors: active & passive

- The need
- Current activities & Future R&D
- Conclusions



Andy Jung

Purdue team members: E. B. Vaca, S. Karmarkar and

UG students: Ben Pulver, Ian Holda, Morgan Shoop

BNL Seminar

My own biased view

June 18th, 2024

Detector “support mechanics”

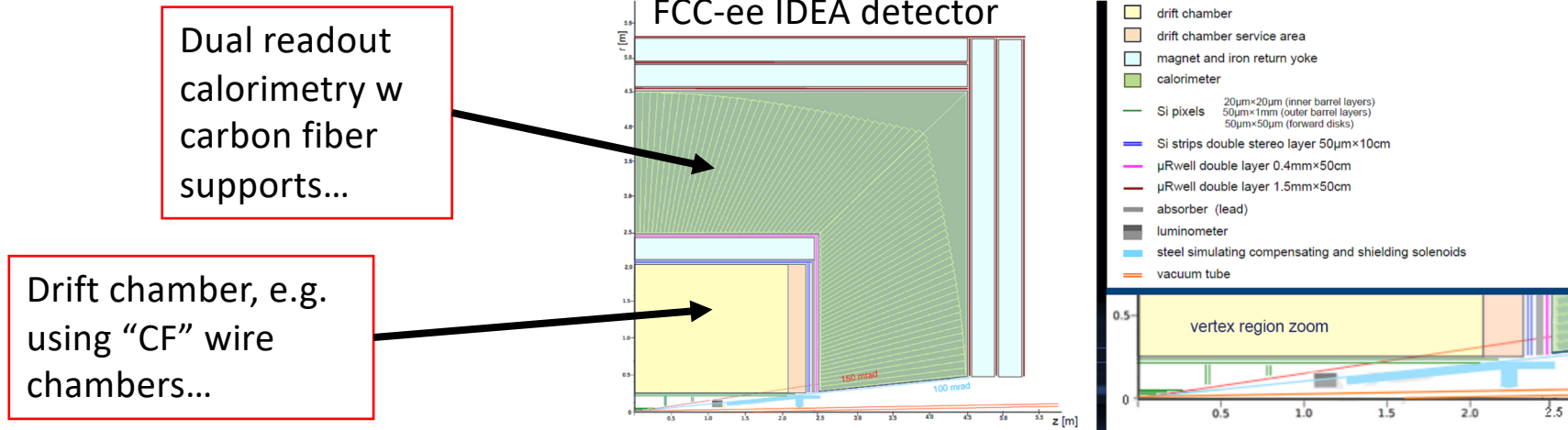


Figure 6: Cross section of the proposed layout for the IDEA detector concept.

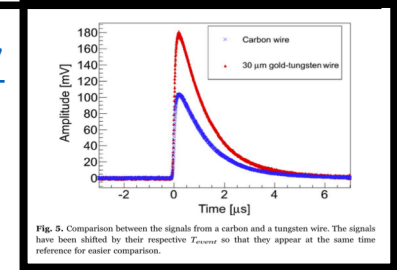
- Example of “large detector” but detector mechanics / services / cooling play a significant role in a detector's performance
- **Highly relevant also to small experiments**

Exchange of ideas & progress across existing collaborations:

- “CPAD RDC 10”: R&D Collaboration for “Detector Mechanics R&D”
- 9 others, so covers also your favorite topic’s <https://cpad-dpf.org>
- Bridges nuclear, high energy physics but space applications / satellites too – broad field!
- Forum on tracking detector mechanics @Purdue: <https://indico.cern.ch/e/ftdm24>

- G. Charles et al. compared gold-plated tungsten wires to carbon wires for applications in multi-wire chambers
- This example: **factor 5 reduction** in material when moving from W+Al to C+Ag/Cu
- Supports is also a topic of interest
 - Volume separation

[NIM A Vol 855, 2017](#)

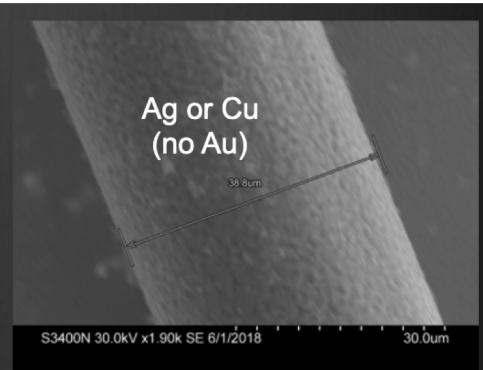


G. Charles et al.

Grancagnolo et al. (INFN)

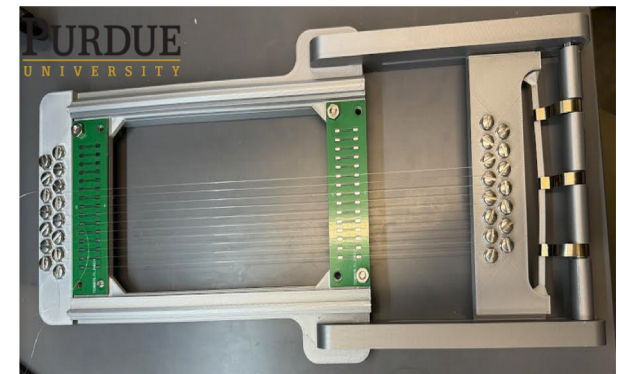
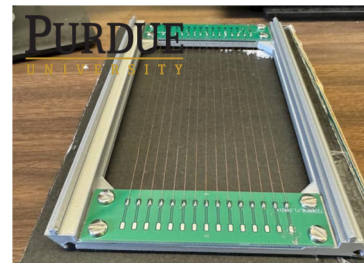
High-power impulse magnetron sputtering (HiPIMS)

physical vapor deposition of thin films based on magnetron sputter deposition (extremely high power densities of the order of kW/cm² in short pulses of tens of μs at low duty cycle <10%)

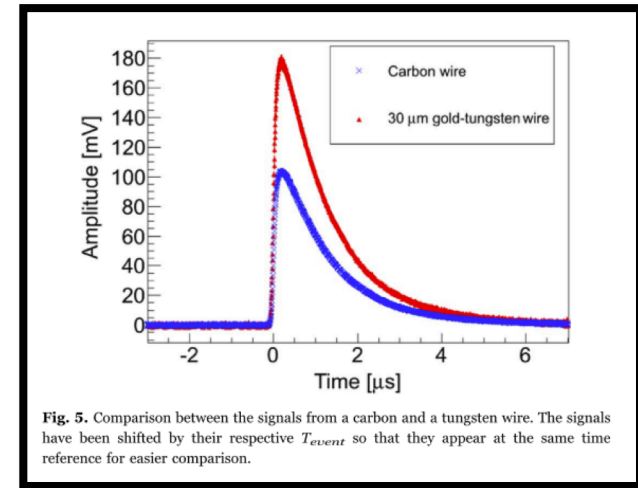


A first bench-test setup @Purdue:

- Printed Circuit boards control the location of each wire
- Chamber is built in layers that can be stacked and offset for alternating sense and cathode wires
- Next steps: Sealed source & record data & spectra...stay tuned



- G. Charles et al. compared gold-plated tungsten wires to carbon wires for applications in multi-wire chambers
- This example: **factor 5 reduction** in material when moving from W+Al to C+Ag/Cu
- Supports also a topic
- Volume separation

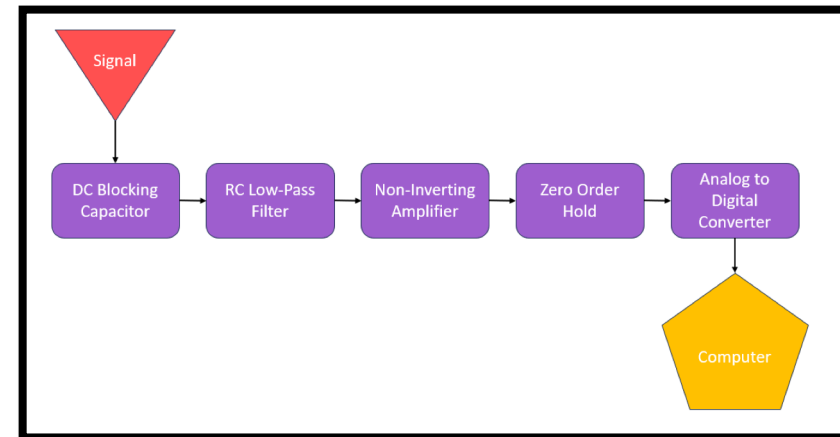
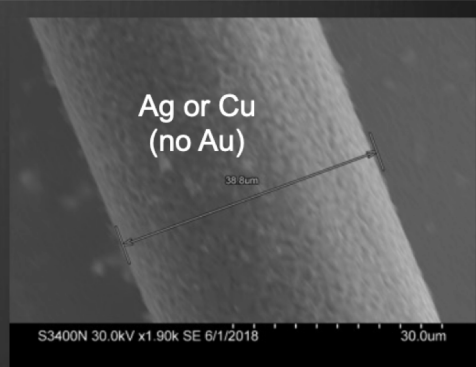


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- Purdue is using 30 μm diameter Dexmat carbon sense wires
- Purdue benchmark is 25 μm diameter tungsten wire from Midwest Tungsten
- Metal coating is a future project
 - Purdue has infrastructure
 - Atomic Layer Deposition (ALD)
 - Chemical Vapor Deposition (CVD)
 - Plasma Enhanced Chemical Vapor Deposition (PECVD)
 - High Density Plasma CVD (HDPCVD)
 - E-beam Evaporation DC/RF Sputtering multi-deposition (E-Beam Evaporation + Sputtering)
 - GaN Molecular Beam Epitaxy (MBE)
 - PVD Pulsed Laser Deposition (PLD)
 - Electrodeposition

